Clock OSC SG5032CCN

Product name SG5032CCN 6.450000 MHz HJGA Product Number / Ordering code X1G0044710052xx

Please refer to the 8.Packing information about xx (last 2 digits)

Output waveform CMOS

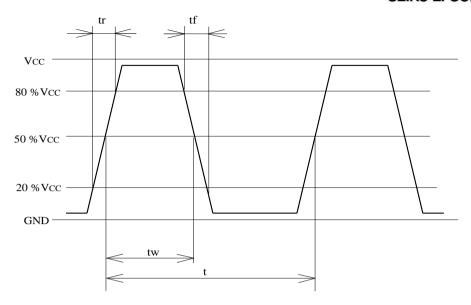
Pb free / Complies with EU RoHS directive

Reference weight Typ. 52 mg

| 1.Absolute maximum ratings | | | | | | | |
|----------------------------|---------|------|------|---------|------|---------------------------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Conditions / Remarks | |
| Maximum supply voltage | Vcc-GND | -0.3 | - | +7 | V | - | |
| Storage temperature | T_stg | -40 | - | +125 | ٥C | Storage as single product | |
| Input voltage | Vin | -0.5 | - | Vcc+0.5 | V | OE terminal | |

| 2.Specifications(charact | teristics) | | | | | | |
|--------------------------|------------------|---------|----------|--------|-------------------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Conditions / Remarks | |
| Output frequency | f0 | | 6.450000 | | MHz | | |
| Supply voltage | Vcc | 4.5 | 5 | 5.5 | V | - | |
| Operating temperature | T_use | -40 | - | +85 | ٥C | - | |
| Frequency tolerance | f_tol | -50 | • | 50 | x10 ⁻⁶ | T_use | |
| Current consumption | Icc | - | • | 20 | mA | No load condition | |
| Stand-by current | I_std | - | - | - | μΑ | - | |
| Disable current | I_dis | - | - | 10.0 | mA | OE = GND | |
| Symmetry | SYM | 40 | - | 60 | % | 50% Vcc Level L_CMOS=<50pF | |
| Output voltage | V_{OH} | Vcc-0.4 | - | - | | - | |
| | V _{OL} | - | 1 | 0.4 | | - | |
| Output load condition | L_CMOS | - | - | 50 | pF | CMOS Load | |
| Input voltage | V_{IH} | 0.8Vcc | 1 | - | | OE terminal | |
| | V_{IL} | - | - | 0.2Vcc | | OE terminal | |
| Rise time | t _r | - | - | 5 | ns | 0.2Vcc to 0.8Vcc Level, L_CMOS=50pF | |
| Fall time | tf | - | - | 5 | ns | 0.2Vcc to 0.8Vcc Level, L_CMOS=50pF | |
| Start-up time | t_str | - | - | 5 | ms | t = 0 at 0.9Vcc | |
| Jitter | t _{DJ} | - | TBD | - | ps | Deterministic Jitter | |
| | t _{RJ} | - | TBD | - | ps | Random Jitter | |
| | t _{RMS} | - | TBD | - | ps | δ(RMS of total distribution) | |
| | t _{p-p} | - | TBD | - | ps | Peak to Peak | |
| | t _{acc} | - | - | - | ps | Accumulated Jitter(δ) n=2 to 50000 cycles | |
| Phase jitter | t _{PJ} | - | TBD | - | ps | Off set Frequency: 12kHz to 20MHz | |
| Phase noise | L(f) | - | - | - | dBc/Hz | Off set 1Hz | |
| | | - | TBD | - | dBc/Hz | Off set 10Hz | |
| | | - | TBD | - | dBc/Hz | Off set 100Hz Vcc=3.3V | |
| | | - | TBD | - | dBc/Hz | Off set 1kHz | |
| | | - | TBD | - | dBc/Hz | Off set 10kHz | |
| | | - | TBD | - | dBc/Hz | Off set 100kHz Vcc=3.3V | |
| | | - | TBD | - | dBc/Hz | Off set 1MHz | |
| Frequency aging | f_age | -5 | - | 5 | x10 ⁻⁶ | @+25°C first year | |
| | | | | | | - | |

3.Timing chart



4.Test circuit

touit

1) Waveform observation

VCC

ST

OF

OE

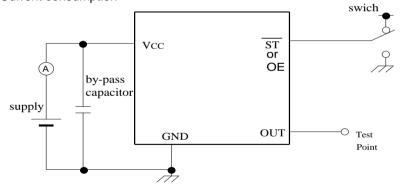
Supply

GND

OUT

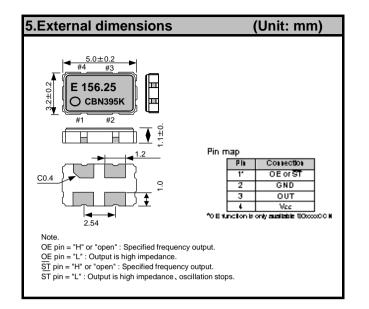
L_CMOS

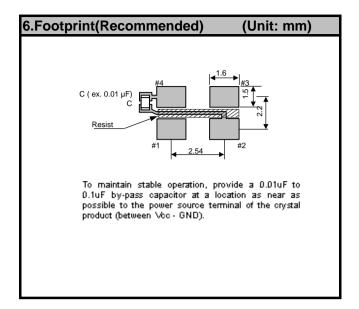
2) Current consumption

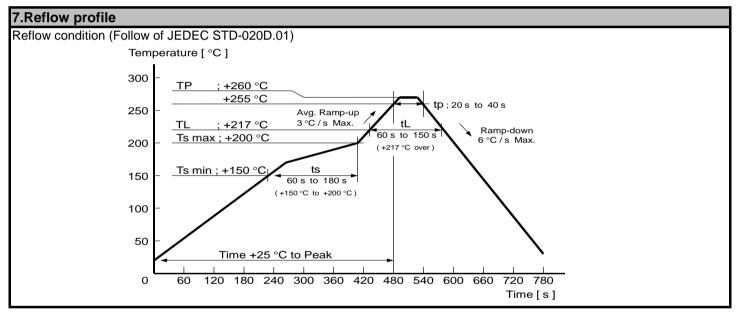


*Current consumption under the disable function should be = GND.

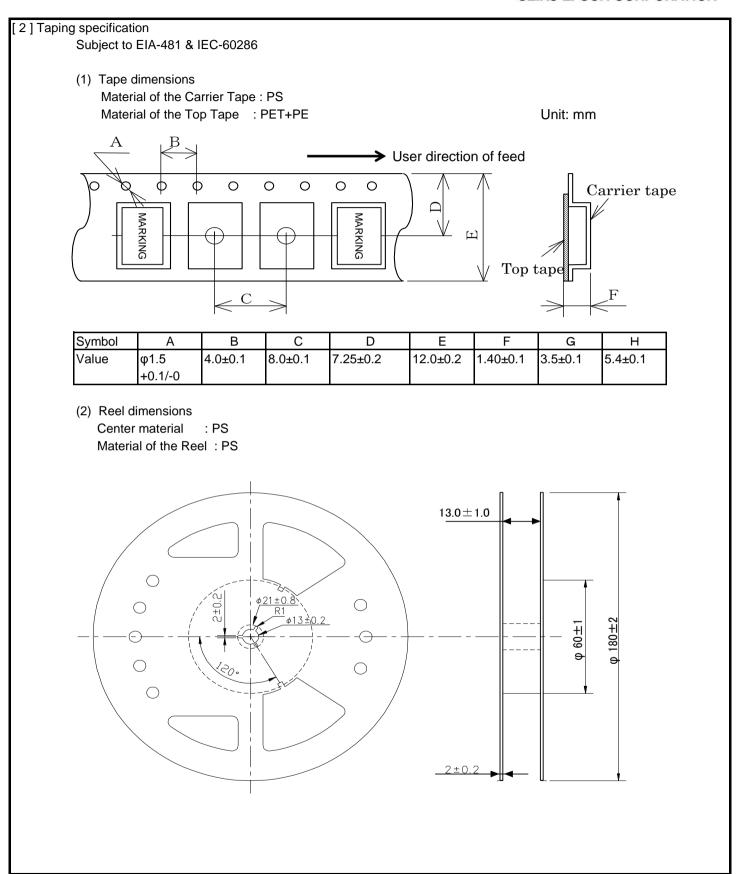
- 3) Condition
- (1) Oscilloscope
- · Band width should be minimum 5 times higher (wider) than measurement frequency.
- · Probe earth should be placed closely from test point and lead length should be as short as possible
- * Recommendable to use miniature socket. (Don't use earth lead.)
- (2) L_CMOS also includes probe capacitance.
- (3) By-pass capacitor (0.01 μ F to 0.1 μ F) is placed closely between VCC and GND.
- (4) Use the current meter whose internal impedance value is small.
- (5) Power supply
- Start up time (0 %VCC to 90 %VCC) of power source should be more than 150 µs.
- · Impedance of power supply should be as lowest as possible.







| 3.Packing | informa | tion | | | |
|------------|--|------------------------------|------------------------------|----------------|--|
| 1]Product |]Product number last 2 digits code(xx) description | | The recommended code is "00" | | |
|) | X1G0044 | 1710052xx | | | |
| ſ | Code | Condition | Code | Condition | |
| ſ | 01 | Any Q'ty vinyl bag(Tape cut) | 13 | 500pcs / Reel | |
| ſ | 11 | Any Q'ty / Reel | 00 | 1000pcs / Reel | |
| | 12 | 250pcs / Reel | | | |



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